AMENDMENTS TO THE CLAIMS

- 1. (Cancelled)
- 2. (Currently Amended) A wiring board comprising:

interlayer insulating films;

multilayer wiring films, each being provided at one of the interlayer insulating films or between two of the interlayer insulating films;

interlayer-connection conductor films, each extending through at least one of the interlayer insulating films and providing an electrical connection between at least two of the interlayer insulating films;

at least one [bare] semiconductor integrated circuit device;

a first shield wiring film on which the semiconductor integrated circuit device is directly mounted;

a second shield wiring film provided so as to oppose the first wiring film with the semiconductor integrated circuit device interposed therebetween; and

a plurality of shield interlayer-connection conductor films that are provided so as to surround a periphery of the semiconductor integrated circuit device and that provide electrical connections between the first shield wiring film and the second shield wiring film, each shield interlayer-connection conductor film extending through at least one of the interlayer insulating films,

wherein the first and second shield wiring films have a gap therebetween, the gap being smaller than one half a wavelength λg of an electromagnetic wave to be prevented from radiating, and

wherein the first and second shield wiring films and the shield interlayer-connection conductor films define a shield cage having a rectangular-parallelepiped inner space with height a, width b, and length c, where $a \le b \le c$, and a wavelength λg of an electromagnetic wave to be prevented from radiating satisfies a relationship:

 $\Delta g > 2/[\{(1/b)^2 + (1/c)^2\}^{1/2}].$

3. (Cancelled)

- 4. (Currently Amended) The wiring board according to one of claims 2 [and 3], wherein at least one of the shield wiring films has a hole, a diameter or a longitudinal side of the hole being smaller than one half a wavelength λg of an electromagnetic wave to be prevented from radiating.
 - .5. (Cancelled)
 - 6. (Currently Amended) A circuit module comprising: the wiring board according to one of claims 2 [and 3]; at least one semiconductor integrated circuit device provided on the wiring board; and at least one passive component provided on the wiring board.
 - 7. (Cancelled)
 - 8. (Cancelled)
 - 9. (Currently Amended) A wiring board comprising: interlayer insulating films;

multilayer wiring films, each being provided at one of the interlayer insulating films or between two of the interlayer insulating films;

interlayer-connection conductor films, each extending through at least one of the interlayer insulating films and providing an electrical connection between at least two of the interlayer insulating films;

at least one semiconductor integrated circuit device;

a first shield wiring film on which the semiconductor integrated circuit device is directly mounted;

a second shield wiring film provided so as to oppose the first wiring film with the semiconductor integrated circuit device interposed therebetween; and

a plurality of shield interlayer-connection conductor films that are provided so as to surround a periphery of the semiconductor integrated circuit device and that provide electrical connections between the first shield wiring film and the second shield wiring film, each shield interlayer-connection conductor film extending through at least one of the interlayer insulating films, wherein the first and second shield wiring films have a gap therebetween, the gap being smaller than one half a wavelength λg of an electromagnetic wave to be prevented from radiating, wherein

at least one of the shield wiring films has a hole, a diameter or a longitudinal side of the hole being smaller than one half a wavelength λg of an electromagnetic wave to be prevented from radiating, and

wherein the first and second shield wiring films and the shield interlayer-connection conductor films define a shield cage having a rectangular-parallelepiped inner space with height a, width b, and length c, where $a \le b \le c$, and a wavelength λg of an electromagnetic wave to be prevented from radiating satisfies a relationship:

$$\lambda g > 2/[\{(1/b)^2 + (1/c)^2\}^{1/2}]$$

10. (Cancelled)

11. (Currently Amended) A circuit module comprising:

the wiring board according to claim 4 or 9;

at least one semiconductor integrated circuit device provided on the wiring board;

and

at least one passive component provided on the wiring board.

12. (Currently Amended) A circuit module comprising: the wiring board according to claim [5] 2; at least one semiconductor integrated circuit device provided on the wiring board;

at least one passive component provided on the wiring board.

and